## PATENT SPECIFICATION

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## COMPLETE SPECIFICATION

## Compositions containing Glycidyl Polyethers of Dihydric Phenols

NAAMLOOZE VENNOOTSCHAP DE BATAAFSCHE PETROLEUM MAATSCHAPPIJ, of 30, Carel van Bylandtlaan, The Hague, The Netherlands, a company organised under the laws of The Netherlands, do hereby declare the invention, for which we pray that a patent may be granted to us, and the method by which it is to be performed, to be particularly described in and by the following state-10 ment:

This invention relates to new compositions of matter containing glycidyl polyethers of dihydric phenols, which compositions cure to hard tough resinous materials upon addition 15 thereto of a curing agent and are particularly but not exclusively suitable for adhesive, potting, casting and surface coating purposes. Useful resins have been prepared heretofore by curing a glycidyl polyether of a dihydric

20 phenol with the aid of various curing agents such as amines, dicarboxylic acid anhydrides, and certain acids. The resin-forming ingredient employed for this purpose is the glycidyl polyether of a dihydric phenol. The glycidyl polyether is obtainable by reacting at about 25 50° C. to 150° C at least one male C. to 150° C. at least one mol of epichlorhydrin with one mol of dihydric phenol in the presence of a base such as sodium or potassium hydroxide in amount of about 2 to 30% stoichiometric excess of base to the dihydric 30 phenol. Glycidyl polyethers of low molecular weight are obtainable by mixing a large excess such as about 4 to 10 mols of epichlorhydrin with one mol of dihydric phenol and adding an alkali to the heated mixture while the reac- 35 tion progresses, the addition of the alkali being regulated so that the reaction mixture is kept at or near the neutral point. The unreacted excess of epichlorhydrin is removed by dis-The polyethers are also obtainable by substituting 1,3-dichloro-isopropanol for the epichlorhydrin in the noted methods and using about twice the amount of base.

The predominant constituent of the glycidyl 45 polyether of dihydric phenol is represented by the formula.

50 hydrocarbon radical (which was linked directly to the two hydroxyl groups of starting dihydric phenol), and n is any integer. The glycidyl polyether also contains a small proportion of compounds of similar structure wherein one 55 or both of the glycidyl radicals are replaced by 2,3-dihydroxypropyl radicals (from hydration of glycidyl radicals) and/or 3-choro-2hydroxypropyl radicals (fromincomplete dehydrochlorination). The glycidyl polyether is thus (:0 seen to have a chain of alternating glyceryl and divalent radicals united through ether oxygen with glyceryl radicals in terminal position. The ether oxygen (as distinguished from epoxy oxygen and hydroxyl oxygen is linked to the 65 primary carbon atoms of the glyceryl radicals.

The excess valencies of the glyceryl radicals over those which link epoxide and ether oxygen link and chemically bind hydroxyl groups and chlorine atoms of the hydrated and hyd-

wherein R represents the divalent aromatic rochlorinated glycidyl groups in the molecule, 70 The molecular weight of the glycidyl polyether, which is reflected in the value of n in the above formula, is dependent upon the ratio of epichlorhydrin (or the substitute therefor) to dihydric phenol employed in preparing the 75 polyether. The use of a ratio of about 1.25 mols of epichlorhydrin per mol of dihydric phenol gives glycidyl polyether of intermediate molecular weight and chain length. By in-creasing the ratio of epichlorhydrin to dihydric 80 phenol, the molecular weight is decreased. If the mole ratio of epichlorhydrin to dihydric phenol is about 10:1 the product is essentially the diglycidyl diether of the dihydric phenol with n equal to or closely approaching zero. 85 Likewise, the use of decreasing ratios of epichlorhydrin to dihydric phenol down to a ratio of 1:1 gives products of higher molecular weight.

Although a glycidyl polyether of the highest molecular weight is obtainable by use of low 90

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ratios of epichlorhydrin to dihydric phenol, it is preferred to effect preparation by a different method owing to the fact that removal of the formed salt and excess base from the higher products is so difficult. By reacting less than an equivalent amount of dihydric phenol with a previously prepared glycidyl polyether of dihydric phenol of intermediate molecular weight, there is obtained glycidyl polyether of 10 high molecular weight. The reaction is effected by heating and mixing the dihydric phenol with the intermediate molecular weight glycidyl polyether in a melt and mantaining the temperature at about 150° C. to 200° C. for 16 several hours' time whereby the thermoplastic glycidyl polyether of high molecular weight is obtained.

In using the glycidyl polyether of a dihydric phenol in many applications such as for adhes-20 ive, potting, casting and like purposes, it is desirable and customary to employ a poly-ether which is a mobile liquid at ordinary temperature so as to facilitate spreading or pouring thereof, and such glycidyl polyethers are found 26 amongst those having a low molecular weight. The glycidyl polyether is usually employed in the applications just mentioned in undiluted conditions because incorporation of most inert viscosity reducing solvents with the polyether 30 gives a cured resin which has greatly reduced physical strength as compared to the cured resin from undiluted polyether. While considerable success has been obtained in using a normally liquid glycidyl polyether of a dihydric 35 phenol in adhesive and potting applications, the resulting cured resin lacks certain desirable properties. The cured resin is unduly brittle and lacks desired toughness.

We have now found that a cured resin of 40 improved properties, particularly improved adhesive properties, can be obtained from a mixture of two different glycidyl polyethers of a dihydric phenol wherein a small proportion of glycidyl polyether of high molecular weight 45 is in admixture with glycidyl polyether of low

molecular weight.

According to the present invention there is provided a composition of matter comprising a first glycidyl polyether of a dihydric phenol 50 in admixture with an added 3% to 20% by weight of a second glycidyl polyether of a dihydric phenol and the second glycidyl polyether having dric phenol, said first glycidyl polyether having a Durrans' Mercury Method melting point below 30° C., a 1,2-epoxy equivalency as here-to inafter defined between 1.6 and 2.0 and containing 1 to 1.5 of the aromatic radicals in the average molecule thereof; and said second glycidyl polyether having a Durrans' Mercury Method melting point above 75° C., a 1,2-epoxy equivalency as hereinafter defined of 1.2 to 1.8 and containing at least 4 of the aromatic radicals in the average molecule thereof. The said composition is thus glycidyl polyether of a dihydric phenol of short chain length 65 having low melting point so as to be liquid at

normal temperature in admixture with a small proportion of glycidyl polyether of a dihydric phenol of long chain length baving a high melt ing point so as to be a solid at normal tempera ture. The dihydric phenol from which the two 70 glycidyl polyethers are derived can be the same or different.

The Durran's Mercury Method melting point of the polythers means the melting point as determined by the method of T. H. Durrana 7b for thermoplastic materials described in J. Oil and Colour Chem. Assoc., 12, 173 5 (1929). The method gives quite accurate and repro ducible results.

The number of aromatic radicals in the 80 average molecule of the glycidyl polyether of a dihydric phenol is equal to n+1 wherein n is as described above with respect of the structural formula of the glycidyl polyethers. The value of n is related to the molecular weight 80of the glycidyl polyethers. The molecular weight is conveniently measured by the customary ebullioscopic method with use of ethylene dichloride as solvent for the glycidyl polyether. The value of n is calculated from the 90

$$n = \frac{M-A-146}{A+90}$$

wherein II is the measured molecular weight of the glycidyl polyether, and A is the molecular weight of the divalent aromatic radical 95 contained in the polyether, i.e. the calculated molecular weight of the aromatic radical which is linked directly to the two hydroxyl groups of the dihydric phenol from which the glycidyl polyether is derived.

The 1,2-epoxy equivalency of the glycidyl polyether is defined for the purpose of the present specification and the appended claims as the number of epoxy groups.

contained in the average molecule of the glycidyl polyether. The 1,2 epoxy equivalency is equal to the measured molecular weight divided by the epoxide equivalent weight. The epoxide equivalent weight is the weight of 110 glycidyl polyether which contains and is equivalent to one 1,2-epoxy group. It is determined by heating a weighed sample of the polyether with an excess of O.2N pyridinium chloride in chloroform solution at the boiling point 115 under reflux for two hours whereby the pyridinium chloride quantitatively hydrochlorinates the epoxy groups to chlorhydrin groups. After cooling, the excess pyridinium chloride is back-titrated with O.1N sodium hydroxide in meth- 120 anol to the phenol-phthalein end point. The epoxide equivalent weight is calculated by considering that each molecule of consumed HCl from the pyridinium chloride combines with an epoxy group.

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The composition of the present invention are prepared by mixing the proper proportion of high melting glycidyl polyether with the low melting polyether. In order that the de-5 sired homogeneous mixture will be obtained, it is convenient to add the high melting polyether in finely divided or powdered condition to the low melting polyether which is heated to about 50° C. to 125° C. The mixture is 10 then maintained hot, and is stirred until the mixture homogenizes with solution of the solid polyether in the melt. If desired, the high melting constituent may also be melted before

addition to the low melting component.

The low melting component of the compositions is glycidyl polyether derived from any one of various dihydric phenols. Suitable dihydric phenols. dric phenols include and are exemplified by, but not limited to, such compounds, as resorc-20 inol, 1,1-bis(4-hydroxyphenol) ethane, 1,1-bis (4-hydroxyphenyl)propane, 2,2-bis(4-hydroxyphenyl)propane, 1,1-bis(4-hydroxyphenyl)butane, 2,2-bis(4-hydroxyphenyl)butane, 1,1-bis(4-hydroxyphenyl)butane, 1,1 4-hydroxyphenyl)-2-methylpropane, 26 (4-hydroxyphenyl)-2-meinylpropane, 3-3-bis 26 (4-hydroxyphenyl)-pentane, and 1,1-bis(4-hydroxyphenyl)-2-ethylhexane. Also suitable are isomeric compounds to those listed above wherein the phenolic hydroxyl groups are in the 2,4<sup>1</sup> positions and the 2,2<sup>1</sup> positions. The 80 dihydric phenols are seen to be free from

functional groups other than the phenolic hydroxyl groups.

Although the compositions may contain a glycidyl polyether of a dihydric phenol which 86 has a Durrans' melting point between 20° C. and 30° C. as major component, the desirable properties are best obtained with compositions containing a polyether having a melting point below about 15° C. Preferably the low melting 40 constituent is glycidyl polyether of 2,2-bis(4-hydroxyphenyl)propane having a melting point below 15° C. Particularly from about 5° C. to 12° C. Another very suitable low melting component is the glycidyl polyether of 1,1-bis(4 45 hydroxyphenyl)ethane.

As explained before, the dihydric phenol from which the low melting and high melting glycidyl polyether is derived can be either the same or different. It is generally preferred that 50 both glycidyl polyethers be derived from a single dihydric phenol, and that it be 2,2-bis-4-hydroxyphenyl)propane. However, excellent results are obtained with compositions containing a low melting glycidyl polyether of 1,1-bis 55 (4-hydroxyphenyl)ethane and a high melting

glycidyl polyether of 2,2-bis(4-hydroxyphenyl)

propane.

The high melting component of the compositions is glycidyl polyether of a dihydric positions is glycidyl polyether of a dihydric point above 60 phenol that has a Durrans' melting point above 75° C. and contains at least four (n+1) of the aromatic radicals from the dihydric phenol. The aromatic radical is the whole divalent hydrocarbon radical of the dihydric phenol, 65 i.e. the radical which was linked directly to

the two phenolic hydroxyl groups of the dihydric phenol. For example, the aromatic radical contained in glycidyl polyether of 2,2-bis(4-hydroxyphenyl)propane is the 2,2-bis(4-phenylene) propane radical, and that in the polyether 70 of 1,1-bis(4-hydroxyphenyl)ethane is the 1,1-

bis(4-phenylene)ethane radical. While the long chain constituent of the composition has a Durrans' metling point above 75 best results are obtained with a glycidyl 75 polyether having a melting point considerably above this minimum. Excellent results are obtained with a polyether having a melting point of at least 125° C. There appears to be no particular upper limit to the melting point for 80 suitability, but generally it is not greater than about 180° C. The glycidyl polyethers having a melting point between 125° C. and 180° C. which contain 6 to 15 of the aromatic radicals in the average molecule thereof are very suit- 80 able. Particularly preferred high melting gylcidyl polyether for use in the compositions is the glycidyl polyether of 2,2-bis(4-hydroxy-phenyl)propane having a melting point of from 140° C. to 160° C. All of the high melting 90 gylcidyl polyethers having a 1,2-cpoxy equivalency of about 1.2 to 1.8.

The high melting glycidyl polyethers can be derived from any or the particular dihydric phenols described above in connection with the 95 low melting polyethers. If desired, the high melting polyethers can be prepared from other dihydric phenols such as, for example, 4,41-dihydroxy-diphenyl, bis(4-hydroxyphenyl) methane, 2,2-bis(4-hydroxy-2-methylphenyl) propane, 2,2-bis(4-hydroxy-2-tertiarybutylphenyl) propane, bis(2-hydroxynaphthyl)methane and 5-dihydroxynaphthalene. These dihydric phenols are also free from functional groups than the two phenolic hydroxyl 106 other

The compositions of the present invention consist essentially of the low melting glycidyl polyether in admixture with about an added 3% to 20% by weight of the high melting 110 glycidyl polyether, i.e. the compositions contain 100 parts by weight of low melting constituent and about 3 to 20 parts of high melting component. Very suitable compositions contain about an added 5% to 15% by weight of high 115 melting glycidyl polyether. The compositions may also contain very minor amounts of impurities of various types normally associated with the glycidyl pelyethers including free phenolic compounds such as phenol and/or 120 the dihydric phenol from which the polyethers are derived. The compositions may be entirely free from phenols, but in any event, they contain less than about 0.004 equivalent of phenolic hydroxyl per 100 grams.

According to a preferred embodiment of the present invention the composition, comprising a glycidyl polyether of low molecular weight in admixture with a glycidyl polyether of high molecular weight, may also contain 5% to 25% 130

by weight of a liquid aliphatic polycpoxide. Thus the preferred compositions of the invention contain essentially 100 parts by weight of the low melting constituent, about 3 to 20 5 parts of the high melting component and about 5 to 25 parts of the aliphatic polycpoxide.

The aliphatic polycpoxides employed as the

third component in the preferred composition of the present invention is a mobile liquid hav-10 ing a viscosity of less than about 500 centipoises at 25° C. In being a polyepoxide, the substance contains two or more epoxide groups in the molecule. These may be 1,2-epoxide groups in the terminal positions, or they may 15 be non-terminal epoxide groups. In all cases, the two bonds of the epoxide oxygen atom are linked to different saturated carbon atoms which are adjacent and linked directly together. The polyepoxide is of 20 aliphatic character and thus free of cyclic aromatic hydrocarbon groups as well as being free from reactive functional groups other than

cpoxy and hydroxyl groups. A variety of particular polyepoxide com-25 pounds and sustances are suitable for use in compositions of the present invention. The simplest diepoxide contains at least four carbon atoms as is the case with butadiene dioxide, or 1,2-epoxy-3,4-epoxy-butane. The epoxy groups 80 may be separated from each other by ether,

oxygen or sulphur as in bis(2,3-epoxypropyl) ether, bis(2,3-epoxybutyl)ether, bis(2,3-epoxypropyl) thioether and 1,2-bis(2,3-epoxypropyloxy)ethane. Also suitable are mobile liquid 35 complex polycpoxides obtained from the reaction of at least two mole of epichlorhydrin with a mol of polyhydric alcohol such as glycerol, crythritol, diethylene glycol, pentaerythritol or polyallyl alcohol, in the presence of a catalyst

40 such as BF<sub>3</sub>-ether complex followed by dchydrochlorination of the resulting chlorhydrin polyether with a base such as sodium silicate. Epoxidised triglycerides constitute a preferred class of aliphatic polyepoxides. These

are prepared by epoxidising the olefinic unsaturation contained in the acyl groups of natural oils with per fatty acids such as perace-tic or performic acid. For example, see the methods described in United States Patent No.

50 2,485,160, according to which an unsaturated compound is epoxidized with a mixture of hydrogen peroxide and formic acid at a temperature of 10° to 100° C. said hydrogen peroxide being present in a ratio of 1 to 2 mole, 55 and said formic acid in a ratio of 0.25 to 1.0

mole, for each double bond in each mole of the ester to be epoxidised. Polyepoxides of this type include epoxidised soybean, cottonseed peanut, olive, corn, tobacco seed, perilla, castor,

60 linseed, sunflower and safflower oil. epoxidised vegetable oils are mobile liquids that contain about 2.5 to 5 epoxy groups per molecule. It has been found that epoxidised soybean oil is a particularly suitable member of 65 the preferred class.

The presence of the aliphatic polycpoxide in the composition of the present invention adds greatly to its utility. Furthermore, the function of the polyepoxide in the composition is un expected. The mixture of low melting glycidyl 70 polyether of a dihydric phenol containing the small proportion of added high melting gly cidyl polyether may be a liquid of such high viscosity that it cannot be conveniently spread at normal temperature in applications as an to adhesive. By incorporating the liquid polye poxide therewith, a spreadable composition is obtained. Furthermore, the cured composition retains its high strength properties in upite of the inclusion therein of the liquid aliphatic 80 polyepoxide.

The preferred composition of the present invention is prepared by bringing the three components together into a homogeneous mixture. It is convenient to add the high melting glycidyl 80 polyether in finely divided or powdered condition to the low melting polyether which is heated to about 60° C. to 120° C. and to stir the mixture at the elevated temperature until the high melting polyether dissolves. The aliphatic 90 polycpoxide is then stirred in to complete the

preparation.

The preparation and properties of several typical glycidyl polyethers of dihydric phenols used in compositions of the invention are des- 95 cribed below. The parts and percentages are by weight. The first five preparations relate to low melting polyethers.

Polyether L-1

A solution is prepared by dissolving 2,2-bis 100 (4-hydroxyphenyl)propane in slightly aqueous epichlorhydrin in the proportion of 5130 parts (22.5 mols) of the dihydric phenol in 20812 parts (225 mols) of epichlorhydrin and 104 parts of water. The solution is prepared in a 105 kettle provided with heating and cooling equipment, agitator, distillation condenser and receiver. A total of 1880 parts of solid 97.5% scdium hydroxide, corresponding to 2.04 mols of sodium hydroxide per mol of bis-phenol [10] (2% excess) is added in instalments. The first instalment of 300 parts of sodium hydroxide is added and the mixture heated with efficient agitation. The heating is discontinued as the temperature reaches 80° C. and cooling is 115 started in order to remove exothermic heat of reaction. The control is such that the temperature rises only to about 100° C. When the exothermic reaction has ceased and the temperature has fallen to 97° C. a further addition 120 of 316 parts of sodium hydroxide is made and similar further additions are effected at successive intervals. An exothermic reaction takes place after each addition. Sufficient cooling is applied so there is gentle distillation of cpich- 125 lorhydrin and water, but the temperature is not allowed to go below about 95° C. No cooling is necessary after the final addition of sodium hydroxide, After the last addition of

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5	sodium hydroxide with completion of the reaction, the excess epichlorhydrin is removed by vacuum distillation with use of a kettle temperature up to 150° C. and a pressure of 50 millimetres pressure (mercury). After completion of the distillation, the residue is cooled to about 90° C. and about 360 parts of benzene are added. Cooling drops the temperature of
10	the mixture to about 40° C. with precipitation of salt from the solution. The salt is removed by filtration and the removed salt carefully washed with about an additional 360 parts of
15	benzene to remove polyether therefrom. The two benzene solutions are combined and distilled to separate the benzene. When the kettle temperature reaches 125° C. vacuum is applied and distillation continued to a kettle temperature of 170° C. at 25 millimetres pressure. The resulting liquid glycidyl polyether of 2,2-
20	bis(4-hydroxyphenyl)propane has the following properties:—  Durrans' melting point 9° C.  Molecular weight 370
25	Epoxide value (epoxide equiva- lents per 100 grams) 0.50 Epoxide equivalent weight - 200
30	Hydroxyl value (hydroxyl equivalents per 100 grams) - 0.08  Per cent. chlorine 0.46  From the above values, n is 0.106 so the average molecular of the polyether contains 1.106 of the aromatic radicals therein. The 1,2-epoxy equivalency of the product is 1.85.
35	POLYETHER L—2 A solution consisting of 11.7 parts of water, 1.22 parts of sodium hydroxide, and 13.38 parts of 2,2-bis(4-hydroxyphenyl)propane is prepared by heating the mixture of ingredients
<b>4</b> 0	to 70° C, and then cooling to 46° C, at which temperature 14.06 parts of epichlorhydrin are added while agitating the mixture. After 25
45	minutes have elapsed, there is added during an additional 15 minutes' time a solution consisting 5.62 parts of sodium hydroxide in 11.7 parts of water. This causes the temperature to rise to 63° C. Washing with water at 20° C. to 30° C. temperature is started 30 minutes

50 is dried by heating to a final temperature of 140° C. in 80 minutes, and cooled rapidly. At room temperature, the product is an extremely viscous, semi-solid having the following pro-55 Durrans' melting point 23° C. Molecular weight 460 (equivalents Epoxide value epoxide per 100 grams) -0.409 Epoxide equivalent weight -Hydroxyl value (equivalents hydroxyl per 100 grams) -244 60 Per cent. chlorine 0.18 The value of n is thus 0.42 and the 1,2epoxy equivalency is 1.88.

POLYETHER L-3 65 Resorcinol is dissolved in epichlorhydrin in the proportion of 1 mol of resorcinol to 10 of epichlorhydrin containing about 1% of water. Solid sodium hydroxide is added in three successive portions in a total amount of 2.04 mols 7() per mol of resorcinol with a short heating up time, and rapid reaction and control of temperature. The product is isolated from benzene solution as described above with reference to Polyether L-1. The obtained glycidyl poly- 75 ether of resorcinol is a viscous liquid having a Durrans' melting point of  $-9^{\circ}$  C., an epoxide equivalent weight of 136.5 and a chlorine content of 0.40%.

POLYETHER L-4 A glycidyl polyether is prepared from 142 parts of 1,1-bis(4-hydroxyphenyl)ethane disparts of 1,1-018(4-flydroxypheny) emails dissolved in 644 parts of epichlorhydrin. The mixture is slowly heated to 70° to 80° C. and a a total of 54.5 parts of solid caustic pellets are 85 slowly added. The temperature rises to about 115° C., but falls to 100° C. as water forms during the reaction, the reaction mixture being refluxed. After about 1.5 hours' reaction time, the excess epichlorhydrin is then distilled off 90 under vacuum. 150 parts of benzene is added to the residue and the mixture is filtered free of salt. The filtered salt is washed with a like amount of fresh benzene and the washing combined with the benzene solution of product. 95 The benzene and traces of epichlorhydrin are then removed from the product by vacuum dis-tillation at pressure of 0.5 millimetres (mer-cury) up to a temperature of about 165° C. The resulting liquid glycidyl polyther has the 101

following properties:—
Durrans' melting point Molecular weight 342 Epoxide value (equivalents epoxide per 100 grams) - Epoxide equivalent weight Hydroxyl value (equivalents
hydroxyl per 100 grams) -0.540 105 Per cent. chlorine 0.73 Calculation gives n=0.06 and the 1,2-epoxy 110 equivalency is 1.85.

POLYETHER L-5 A solution of 100 parts of 1,1- bis(4-hydroxyphenyl)-2-ethylhexane dissolved in 308 parts epichlorhydrin containing 1.3 parts of water is 115 heated to 90° C. Then 27.7 parts of sodium hydroxide are added at a rate sufficient to keep the reaction mixture refluxing at 95° to 100° C. from the heat of reaction. The excess epichlorhydrin is stripped out to a final temperature 120 of 150° C. under 10 millimetres pressure of mercury. Two hundred parts of benzene are added, the precipitated sodium chloride removed by filtration and benzene distilled off to a final temperature of 180° C. at 8 to 10 125 millimetres (mercury) pressure. The resulting viscous glycidyl polyether has the following properties:

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		bis(4 hydroxyphenyl)propane. The heating is
	Durrans' melting point 14° C.	Dis(4 hydroxyphenyr)propane. The hearing and
	Molecular weight - 441	continued for about 2 hours while stirring and
	Epoxide value (equivalents	gradually increasing the temperature to 200
	cpoxide per 100 grams) - 0.39	C. The resulting solid product has the follow
	Epoxide equivalent weight - 256	ing properties:
b	Epoxide equivalent weight 250	Diagrams' melting point = 122" C.
	Hydroxyl value (equivalents	Molecular weight 2900
	hydroxyl per 100 grams) - 0.12	Epoxide value (equivalents
	Per cent, chlorine 1.3	
	With this product, $n=0.18$ and the 1,2	
10	epoxy equivalency is 1.72. Preparation and pro-	Epoxide equivalent weight - 1670 76
10	perties of nigh melting glycidyl polyethers will	Hydroxyl value (equivalents
	next be exemplified.	hydroxyl per 100 grams) - 0.37
	POLYETHER H—1	hydroxyl per 100 grams) - 0.37 Per cent, chlorine 0.13
	1 Co. 1 mid- an aritator 228 parts	The value of $n$ is 9.0 and the 1,2 epoxy
	In a vessel fitted with an agitator, 228 parts	
15	of 2,2-bis(4 hydroxyphenyl)propane and 55	Citity there's just and a second
	parts of sodium hydroxide as a 10% aqueous	POLYETHER H=4
	solution are introduced and heated to about	By using 7.75 parts of 2,2-bis(4 hydroxy-
	45 C. whercupon 113 parts of epichlorhyrin	phenyl)propane with 100 parts of Polyether
	are added rapidly while agitating the mixture	If and effecting the reaction under the sume
	are added rapidly will agree is then gradu-	conditions as described above for Polyether 85
20	The temperature of the mixture is then gradu-	11 -3, there is obtained glycidyl polyether hav-
	ally increased and maintained at about 95° C.	ing the following properties:—
	for 80 minutes. The mixture separates into a	Durrans' melting point - 148' C.
	two-phase system and the aqueous layer in	
	drawn off from the product of syrupy consis-	Molecular weight 3/30
95	tency which forms. The latter is washed with	Epoxide value (equivalents 90
200	hat water while molten until the wash water	epoxide per 100 grams) 0.036
	is neutral to litmus. The product is then	Epoxide equivalent weight - 2780
	drained and dried by heating to a final tem-	Hydroxyl value (equivalents
	perature of 130° C. The resulting solid gly-	hydroxyl per 100 grams) - 0.40
	perature of 150 C. The resulting properties	Per cent, chlorine 0.13 96
- 30	cidyl polycther has the following properties:——  Durrans' melting point - 98° C.	This solid product has n=12.0 and an
	Training Metalling Francisco	
	Molecular weight 1400	The compositions of the present inventions
	Epoxide value (equivalents	The compositions of the present inventions
	cooxide per 100 grams) 0.12	are prepared from the above-described poly-
36	Epoxide equivalent weight - 834	ethers by adding and mixing 3 to 20 parts, 100
0.7	Hydroxyl value (equivalents	preferably 5 or 10 parts, by weight of small
	hydroxyl per 100 grams) 0.348	particles of any one of Polyether H-1, H-2,
	Per cent. chlorine 0.14	H-3 or H-4 with 100 parts by weight of
	The value of $n$ is 3.74 and the 1,2-epoxy	any one of Polyether L-1, L-2, 1-3, L-4
4.1	The value of 18 is 5.77 and === -7 - 7	or L-5 heated to about 80° C. to 100° C., 10.
41)	equivalency is 1.68. POLYETHER H—2	and continuing the heating at such temperature
	To 100 parts of Polyether L-1, there are	until the particles dissolve and homogenise,
	10 100 parts of Polyetter 13-15 dicke are	which occurs in not over about 2 hours' time.
	added 45 parts of 2,2-bis(4-hydroxyphenyl)	Upon cooling to room temperature of about
	propane and the mixture is heated at 200° C.	25° C. the compositions are liquid although 11(
45	for 90 minutes with occasional stirring. The	
	proportion of dihydric phenol is such that	some have high viscosity.
	about 0.78 equivalent of phenonic hydroxyl	Viscosity data on certain compositions of the
	group is initially present per equivalent or	present invention are tabulated below, the vis-
	enovide in the glycidyl polyether. The resulting	cosity having been measured with a Brookfield
50	solid product has the following properties:—	Viscosimeter at 25° C. The viscosity of Poly-11
(IC	Durrans' melting point 86° C.  Molecular weight 1230	ether L-1 is 12,400 centipoises and that of
	Molecular weight 1230	Polyether L-2 is above 100,000 centipoises.
	Wolceman weight	The upper limits of measurement with the
	Epoxide value (equivalents epoxide per 100 grams) - 0.117	Brookfield Viscosimeter is 100,000 centipoises.
		The parts are by weight for the tabulated com- 12
5		
	Hydroxyl value (equivalents	positions.
	hydroxyl per 100 grams) - 0.354	TABLE I.
	Per cent chlorine 0.32	No. Composition Viscosity
	This high melting thermoplastic glycidyl	100 parts polyether L-1 plus:
gr	polyether of 2,2-bis(4-hyroxyphenyl)propane	1 5 parts polyether H—1 30,200 12
U.	has $n=3.1$ and a 1,2-epoxy equivalency of	2 5 parts polyether H—3 45,500
	1.44.	3 5 parts polyether H—4 54,600
	POLYETHER H—3	4 10 parts polyether H-1 64,400
	To 100 parts of Polyether H—1 heated to	
	10 100 parts of rolycular in-1 matter to	6 10 parts polyether H—4 above 100,000 13
ţ) t	about 150° C. there are added 5 parts of 2,2-	0 F Ford

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In order to effect cure, 4.76% by weight of piperidine was added to each of Compositions Nos. 1 to 3, and 4.55% by weight to each of Compositions Nos. 4 to 6 The mixtures were 5 then heated for 24 hours in an air oven set at 60° C. The resulting cured resins were hard and tough.

Various optional ingredients can be incorporated with the compositions of the present 10 invention. Their choice and amount is largely governed by the particular use to which the

compositions are put.

Certain compositions of the present invention may contain a cyano-substituted hydrocarbon 15 as viscosity reducing diluent. They are normally liquid in having a melting point below 10° C. and contain one or more nitrile groups linked to the hydrocarbon radical which may be of any type desired, saturated or unsatur-20 ated; aliphatic, alicyclic or aromatic. Although it has been found that acetonitrile or methyl cyanide is particularly preferred, examples of other suitable compounds include propionitrile, butyronitrile, capronitrile, lauronitrile, acry-25 lonitrile, methacrylonitrile, crotonitrile, oleonitrile, 2-cyano-1,3-butadiene, succinonitrile, glutaronitrile, adiponitrile, fumaronitrile, allylmalononitrile, cyclopentyl cyanide, cyclohexyl cyanide, 1,2-dicyanocyclohexane, benzonitrile, 80 and phenyl-acetonitrile. In general, it is preferred to employ a cyano-substituted saturated hydrocarbon containing one to two cyanide groups, which compound contains 2 to 8 carbon atoms. Good results are obtained with alkyl 85 cyanides containing up to 4 carbon atoms, although higher members of this class containing up to 12 carbon atoms and having melting points below 10° C may be used, if desired.

The compositions may also contain one or 40 more comminuted inorganic fillers such as asbestos, aluminium oxide, silica, bauxite, zinc oxide, china clay, titanium oxide and silicon

carbide.

In using the composition for adhesive purposes in metal-to-metal bonding, it has been
found useful also to include an inert solid comminuted filler in the composition in amount of
about an added 5% to 400% by weight based
upon the low melting glycidyl polyether in the
composition. Inorganic fillers such as iron oxide
or asbestos, not only contribute to the shear
strength of the cured resin bond, but also improve the retention of high strength at elevated
temperatures.

55 In using the compositions of the present invention, a hardening agent is incorporated therewith. Upon the addition of the hardening agent, the composition begins to cure and harden even at ordinary temperature. A great 60 variety of substances are now known to be hardening agents for the resin-forming ingredients of the composition such as alkalies like sodium or potassium hyroxide; alkali phenoxides like sodium phenoxides; carboxylic 65 acids or anhydrides such as formic acid, oxalic

acid or phthalic anhydride; Friedel-Crafts metal halides like aluminium chloride, zinc chloride, ferric chloride, or boron trifluoride, as well as complexes thereof with ethers, acid anhydrides, ketones and diazonium salis; phos- 70 pheric acid and partial esters thereof including n-butyl orthophosphate, diethyl orthophosphate and hexaethyl tetraphosphate; and amino compounds such as triethyl amine, ethylene diamine, diethyl amine, diethylene triamine, 75 triethylene tetramine, pyridine, piperidine, N.N diethyl-1,3-propanediamine, dicyandiamide and melamine. The hardening agent is added and mixed in with the composition in order to effect hardening. The amounts vary considerably de-80 pending upon the particular agent employed. For the alkalies or phenoxides, 2 to 4 per cent is suitable. With phosphoric acid and esters thereof, good results are obtained with 1 to 10 per cent added. The amino compounds are 85 used in amounts or about 5 to 15 per cent and the others involve the addition of about 1 to

20 per cent.

When using the composition of the present invention for adhesive purposes, the composi-90 tion, which may also contain various optional constituents, has added thereto sufficient hardening agent and the mixture is applied as by spreading upon a surface desired to be united to another surface as a layer of about 95 0.0005 to 0.1 inch thickness. The adhesive mixture is suitable for uniting various surfaces such as wood to wood, wood to metal, metal to metal, resin to resin, or any combination thereof. After application and joinder of the 100 surfaces desired to be united, the adhered articles are allowed to cure for a period of from about 30 minutes to a day or more, depending upon the hardening agent and temperature employed. In this time when heating is omitted, 105 the adhesive composition will set up to a solid which will permit ordinary handling thereof. Maximum strength for the adhesive layer will be reached within one day to two weeks. While the application is effected at ordinary atmos- 110 pheric temperature and the curing may also be permitted to occur at such imperature, the curing may be effected in shorter times at elevated temperatures such as up to 75° C., 100° C., 150° C., or even higher in some cases. In cases 115 where elevated curing temperature is employed, the chosen temperature is below the boiling temperature of the lowest boiling constituent contained in the mixture, and preferably, it is at least 20° C. below such boiling temperature. 120

The cured resin from the compositions of the present invention has very high physical strength and toughness as may be observed by subjecting the resin to thermal shock tests. Like other resinous materials, the cured resin 125 has low heat conductivity. If a sizable sample of the resin is thrust into a medium of appreciably different temperature from the initial temperature of the sample, great physical strain occurs in the outer part of the sample from 130

thermal expansion or contraction with the result that the sample will crack unless it has the strength and toughness needed to withscand the test. For example, a 50 gram sample of the composition containing 100 parts by weight of Polyether L. I and 10 parts of Polyemer H 3 was prepared and placed in a paper cup along with another 50 gram sample of Polyether 1, 1 alone in another cup. To each 10 were added 2.5 grams of piperidine as curing agent. The samples were resinified to hard resins by heating for 24 hours in an oven set at 60 C. The paper cups were removed and the cured resin samples were subjected to the 15 following thermal shock test. The samples were placed in an oven set at 150 °C. for 1 hour, then removed and allowed to cool at room temperature for 1 hour, next thrust into crushed solid carbon dioxide (dry ice) at about 70° 20 C. for I hour, and then allowed to warm at

room temperature during \( \frac{1}{2} \) hour. This cyclo was then repeated. It was found that the resin sample from resinification of Polyether L-\( \frac{1}{2} \) alone cracked in the hot portion of the fifth \( 25 \) cycle. On the other hand, the resin sample from the composition of the invention passed seven cycles without cracking and then also passed fifty more cycles as described except that the oven temperature was increased to \( 200 \) C. The test was then stopped without this resin sample being fractured or cracked.

When employed in adhesive formulations, the compositions of the invention have the important advantage of imparting to the cured 35 resin bond great resistance against mechanical shock. In other words, the impact strength obtained with cured adhesives from the compositions containing the mixture of high melting and low melting glycidyl polyethers is 40 markedly higher than that obtained with a

cuted adhesive from a single glycidyl polyeth i. The impact strength or resistance against mechanical shock is of prime importance especially when the adhesives are employed for metal to metal bonding.

The compositions of the present invention when employed in adhesive formulations have a high shear strength both at low and at high temperatures. Therefore the compositions can be utilised in many applications for which prior both compositions were unsuitable because they did not retain high shear strength at elevated

temperatures. The unusually high impact obtained with compositions of the invention bb will be illustrated. Formulations were prepared containing the constituents and amounts given in Table II below. Allyl glycidyl ether was incorporated in the formulations in such amounts as to render the compositions liquid, 60 A formulation employing a single glycidyl polyether was included for comparison. The parts were by weight. To each composition there were added 8 parts of N,N-dicthyl-1,3-propane-diamine as curing agent. The freshly prepared 65 mixtures were spread on a one-inch square surface of clean aluminium blocks of about onequarter inch thickness with a 5 millimetres doctor blade. Coated surfaces of two blocks were joined and the adhesive cured by heating 70 the joined blocks in an oven for 45 minutes at 200 F. After cooling the Izod impact strength was determined according to ASTM method D-950-47T. The results are given in the following table. For the compositions of the 75 present invention, it was found that the impact strength was greater than the limit of the testing machine and amounted to more than 15 foot-pounds per square inch.

80	Low Melting Polyether	High Melting Polyether	Allyl Glycidyl Ether as Diluent	Impact Strength foot-pounds per square inch
85	100 parts L—1	10 parts H—1	1 part	>15.0
	100 parts L—1	10 parts H—2	3.5 parts	>15.0
	100 parts L—1	10 parts H—3	4.5 parts	>15.0
	85 parts L—2	none	15 parts	1.6

The compositions of the present invention are very useful in adhesives for joining a variety of metals as will be evident from the follow90 ing. The composition consisted of 100 parts by weight of Polyether L—1 containing 5 parts of Polyether H—3 to which were added 5 parts of piperidine as curing agent. The freshly prepared mixture was spread on a one-inch square surface of each of two blocks of the metals listed in Table III below with a 5 millimetres doctor blade. The coated surfaces were joined

and the adhesive was cured by baking the joined blocks in an oven for 24 hours at 60° C. After cooling, the blocks were subjected to the 100 block shear test of the United States Army-Navy-Civil Committee on Aircraft Design Criteria: "Wood Aircraft Inspection and Fabrication", ANC—19 (Dec. 20, 1943), discussed in an article by R. C. Rinker and G. M. 105 Kline, Modern Plastics, Volume 23, page 164, 1945. The shear strengths at 77° F. for the blocks were as follows:—

	Table III.		
	Block Material	Shear Streng Pounds per square incl	•
5	Aluminium (24ST) -	- 3030	
	Aluminium (Alclad) -	- 5390	
	Magnesium	- 2045	
	Stainless steel (18—8) -	- 4045	
10	Copper	- 3670	
10	Brass	- 1965	
	Hot rolled steel	- 2740	
	Cold rolled steel	- 3120	
	Cold plated steel	- 1460	
	Silver plated steel -	- 1770	
15	Nickel	- 4975	

Certain preferred compositions of the present invention containing an aliphatic polyepoxide and their performance will be illustrated in the following examples. The parts are by weight.

20 In testing the compositions, the freshly prepared adhesive mixture of the composition and the curing agent was applied to clean aluminium sheets with a 5 millimetres doctor blade, the coated surfaces were joined, and after baking to effect cure, the tensile shear strength

and the bend strength were determined as described in U.S.A.F. Specification 14164. The impact strength was determined according to ASTM method D—950—47T with clean aluminium blocks prepared in like manner. 3

EXAMPLE 1.

Base compositions were prepared containing 100 parts of Polyether L—1, 10 parts of Polyether H—4, and 12 parts of epoxidised soybean oil. The epoxidised soybean oil con-35 tained about 3.6 epoxy groups per molecule and was the same as the epoxidised oil to be referred to in subsequent examples. Fine asbestos fibre (Johns-Manville 7TF—2) in amounts listed in the following table along with 40 10 parts of N,N-diethyl-1,3-propanediamine were added to and mixed with the base compositions. The freshly prepared adhesive mixture was tested for joining aluminium, cure being effected by baking for 45 minutes at 45 200° F. in an oven. In all cases, the impact strength at both -70° F. and 180° F. was found to be more than 15 foot-pounds per square inch. The tensile shear strength in pounds per square inch (psi) and the bend test 50 results are tabulated below:—

	Parts of	Tensile Shear Strength, p	si Bend Test, lbs.
	Asbestos	at 77° F. at 180° F.	at 77° F.
<b>5</b> 5	0	2585 1960	144
	20	3115 2880	200
	30	3600 3560	180
	40	3220 3090	176
	50	3390 2810	184

It will be observed from the foregoing results 60 that the composition of the present invention in cured condition gives very high shear strengths not only at room temperature (77° F.) but also at the elevated temperature of test, 180° F.

EXAMPLE 2.

The effect of various amounts of epoxidised soybean oil in the composition will be illus-

65

trated in this example. Each mixture contained 100 parts of Polyether L—1, 10 parts of Polyether H—4, 30 parts of the fine asbestos fibre 70 and 8 parts of N,N-diethyl-1,3-propanediamine as well as the amounts of the epoxidised soybean oil listed in the table below. The mixtures were applied as adhesive to aluminium and cured by baking for 45 minutes at 200° F. 75

	Parts of Epoxidised Soybean Oil	Tensile Shear Strength, psi at 77° F. at -70° F.
80	8 10 12 16 20	2790     2300       3500     2565       3250     2725       3285     2515       3245     2370

It will be noted from the foregoing results that very high shear strengths at the low tem-85 perature of  $-70^{\circ}$  F. are obtained.

EXAMPLE 3.

The use of other liquid aliphatic poly-

epoxides in the composition will be illustrated in this example. Base mixtures were prepared containing 100 parts of Polyether L—1, 10 90 parts of Polyether H—4, and 30 parts of the fine asbestos fibre. The adhesive mixtures also contained the liquid aliphatic polyepoxides

given in the table below in the amounts indicated and the listed amounts of N,N diethyl-1,3 propanediamine as curing agent. The mix-

tures were applied as adhesives to aluminum and cured by baking for 45 minutes at 200 P. 6 The results follow:

								Tensile	osi, at: 77 <b>-1</b> 6 alter		
1,0		Liq	uid Polycp	oxide		(	Pacts Juring gent	70° F.	77" F.	180 F.	I hour in boiling II.O
	 12 o.	arts	cpoxidiscd	soybear	ı oil	_	8	2620	3390	3445	3400
	4 0	ereti	diglycidyl	топос			8	2185	2510		
		arrs			-		8	2025	3100		2760
	.8	17	11	"		_	8	2000	2890	2850	2560
	12	"	11	"	-		8	1980	2670		2540
15	16	"	polyallyl g	ور د البدارة بيدا	- ootvetl	14°E	10	2730	3130	2825	
	. 8	"	poryunyi g	lyciciyi	Julyen	101	12	2735	2970	2810	
	12	31	11	27	"			3090	3500	3265	
	16	"	,,	"	>>		16	.1020	5.700	5405	
					_						

EXAMPLE 4.

The preferred composition of the present invention contains 100 parts of Polyether I. -1, 10 parts of Polyether H-4, 12 parts of the employed in adhesive use of the composition asbestos fibre. Various curing agents were ceployed in adhesive use of the composition for joining aluminium, the cure being effected by baking for 45 minutes at 200° F. The

results are given in the following table which indicates the amount of curing agent used in the composition. For brevity, the curing agents 30 identified as "Triacetate", "Triisobutyrate", etc., were amine salts prepared by neutralising one mol of 2,4,6-tri(dimethylaminomethyl) phenol with three mols of the appropriate fatty acid to form the indicated salt.

	Curing Agent Parts and Name	Tensile S	Shear Streng 77° F.	gth, psi 180° F.	Bend Test, lbs. at 77 F.
40	12 triisobutyrate	- 2830 c 2820 - 2430 - 2485 - 2235	3505 3630 3320 3535 3210	3600 3405 3180 2785 1810	189 197 166 —
<b>4</b> 5	17.5 trifaurate	- 2490 - 2535	3355 3500	1605 1655	158 177

Example 5.

The use of various finely divided fillers in a preferred composition of the present invention will be illustrated. In each case, the base composition consisted of 100 parts of Polyether L—1, 10 parts of Polyether H—4 and 12 parts of the epoxidised soybean oil as well as the amount and kind of filler listed in the table

below and 10 parts of N,N-diethyl-1,3-propane-diamine as curing agent. Before adding the 55 curing agent, all the compositions except the first had approximately the same viscosity. The mixtures were tested as adhesives for aluminium, cure being effected by baking for 3 hours at 200° F. The results follow:—

	<del></del>			•
	Filler	Parts Filler	Tensile Shear at 77° F.	Strength, psi at 180° F.
•	None	0	2715	1355
_	Asbestos	- 30	3330	2795
5	Zinc oxide	· 122	2395	2660
	Titanium oxide	163	2465	3080
	Calcium oxide	106	2835	2680
	Nickelic oxide	244	2370	3050
	Lead oxide	264	2475	3415
10	Manganese oxide -	- 346	2610	2805
	Cupric oxide	- 382	2535	1920
	Stannic oxide	- 130	2507	2815
	Ferric oxide -	122	2795	3480
	Alumina	85	2835	
15	Glass floc			3250
10		- 38	3185	1840
	Hydrated silicon dioxide		3485	3075
	Cellulose floc	. 8	2515	1820
	Silica	- 8	2245	1825
	Nylon floc	25	3285	2005
20	Rice hull floc	61	2885	2015
		32	2005	2013

Example 6.

The use of various times and temperatures of cure will be illustrated. There was employed the preferred composition containing 100 parts 25 of Polyether L—1, 10 parts of Polyether H—4, 12 parts of the epoxidised soybean oil, and 30

parts of fine asbestos fibre to which was added 8 parts of N<sub>2</sub>N-diethyl-1,3-propanediamine. The mixtures were again employed as adhesives to bond aluminium together using the times 30 and temperatures of cure indicated in the following table:—

	Cure Conditions		Tensile Shear Strength, psi at -70° F. at 77° F at 180° F.					
35	2 hrs. at 165° F 45 min. at 200° F. 45 min. at 240° F.	-	-	-	-	2115 2620 3180	3215 3390 3270	3640 3445 2860

EXAMPLE 7.

For purposes of comparison, the performance 40 of a composition of the present invention will be contrasted with the performance of a similar composition which contained furfural, a viscosity reducing diluent recommended by prior workers in the art, in place of a liquid aliphatic polyepoxide. The composition of the present invention contained 100 parts of Polyether L—1, 10 parts of Polyether H—4, 12 parts of the epoxidised soybean oil and 30 parts of the

fine asbestos fibre to which were added 10 parts of N,N-diethyl-1,3-propanediamine as curing 50 agent to form an adhesive mixture. The other adhesive mixture contained the same kind and amounts of constituents except that 12 parts of furfural were substituted for the 12 parts of epoxidised soybean oil. The two mixtures were 55 tested as adhesives to join aluminium, cure being effected by baking for 45 minutes at 200° F. The results follow:—

60	Viscosity Reducing Component.	Tensile Shear Strength, psi at -70° F. at 77° F. at 180° F.
	Furfural Epoxidised soybean oil	2555 2725 1525 2800 3570 3630

It will be observed that the shear strengths obtained with the composition of the present invention are much superior to those obtained with the corresponding composition containing furfural. This is especially true for the strengths at the elevated temperature of 180° F. where composition of the invention gives a strength

almost 250% greater than that from the fur-70 fural-containing composition.

What we claim is:

1. A composition of matter comprising a first glycidyl polyether of a dihydric phenol in admixture with an added 3% to 20% by 75 weight of a second glycidyl polyether of a di-

hydric phenol, said first glycidyl polyether having a Durrans' Mercury Method melting point below 30. C. a 1,2 epoxy equivalency as hereinbefore defined between 1.6 and 2.0, and 5 containing 1 to 1.5 of the aromatic radicals in the average molecule thereof; and said second glycidyl polyether having a Durrans' Mercury Method melting point above 75° C., a 1,2-cpoxy equivalency as hereinbefore defined of 1.2 to 1.8 and containing at least 4 of the aromatic radicals in the average molecule thereof.

A composition as claimed in claim 1, comprising also a liquid aliphatic polyepoxide as hereinbefore defined having a viscosity of less

than 500 centipoises at 25° C.

12

3. A composition as claimed in claim 1 or claim 2, wherein the dihydric phenol of both glycidyl polyethers is 2,2-bis(4-hydroxyphenyl) 20 propane, and the Durrans' Mercury Method melting point of the first glycidyl polyether is below 15° C, and that of the second is between 125° C, and 180° C.

4. A composition as claimed in any one of the preceding claims, wherein the percentage by weight of the second glycidyl polyether is 5 to 10%, the dihydric phenol of both glycidyl polyethers is 2,2-bis(4-hydroxyphenyl)propane, and the Durrans' Mercury Method melting 30 point of the first glycidyl polyether is from 5 °C. to 12" C. and that of the second glycidyl

polyether is from 140° C, to 160° C, 5. A composition as claimed in any one of claims 2 to 4, wherein the liquid aliphatic polyepoxide is an epoxidised triglyceride, constaining 2.5 to 5 epoxy groups per molecule.

6. A composition as claimed in any one of claims 2 to 4, wherein the liquid aliphatic polyepoxide is diglycidyl monoether or polyallyl glycidyl ether.

7. A process for the preparation of a composition of matter substantially as hereinbefore described with reference to the specific examples.

8. A composition of matter substantially as 45 hereinbefore described with reference to the specific examples.

9. A resin prepared by curing a composition of matter as claimed in any one of the preceding claims 1 to 6 and 8.

10. A composition suitable for use as an adhesive and comprising a composition of matter as claimed in any one of claims 1 to 6 and 8 and a curing agent.

11. A method of adhesively uniting surfaces 65 which comprises introducing between the surfaces a composition as claimed in claim 10 and allowing or causing cuting to take place.

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